# 3/4W, 2010 Low Resistance Chip Resistor

#### 1. Scope

This specification applies to 2.5mm x 5.0mm size 3/4W, fixed metal film chip resistors rectangular type for use in electronic equipment.

## 2. Type Designation



Where

- (1) Series No.
- (2) L = L Type
- (3) Resistance value:

For example - -

 $R005 = 5m\Omega$ 

 $R050 = 50 \text{m}\Omega$ 

(4) Resistance tolerance

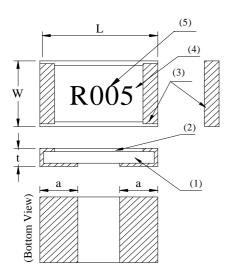
 $F = \pm 1\%$ 

 $G = \pm 2\%$ 

 $J = \pm 5\%$ 

## 3. Outline Designation and Marking

### 3-1 Outline Designation



- (1) Substrate Alumina 96%
  (2) Resistor Ni alloy
  (3) Terminals Sn (on Cu )
- (4) Protection coat Heat resistive epoxy resin
- (5) Marking Epoxy resin

Code Letter	Dimensions (mm)				
	RL2550				
L	$5.0 \pm 0.20$				
W	$2.5 \pm 0.20$				
a	$1.00 \pm 0.15$				
f	$(>3 \text{m}\Omega) \ 0.80 \pm 0.15$				
t	$(3m\Omega)  0.95 \pm 0.15$				

Figure 1. Construction and Dimensions

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## 3-2 Marking

Resistance value is marked on the top surface. Ex.)  $5m\Omega \rightarrow R005$  $47m\Omega \rightarrow R047$ 

### 4. Ratings

## 4-1 Specification

Power Ratings*	3/4W
Resistance Value	4 ~ 50mΩ
Temperature Coefficient of Resistance	(≤10mΩ) 100ppm/°C (>10mΩ) 50ppm/°C
Resistance Tolerance	±1%, ±2%, ±5%
Insulation Resistance	Over $100 \mathrm{M}\Omega$
Maximum Working Voltage (V)	(P*R) <sup>1/2</sup>

#### Note \*:

Power ratings is based on continuous full load operation at rated ambient temperature of  $70^{\circ}\text{C}$ . For resistors operated at ambient temperature in excess of  $70^{\circ}\text{C}$ , the maximum load shall be derated in accordance with the following curve.

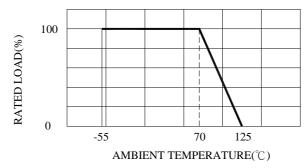


Figure 2. : Power Temperature Derating Curve

### 4-2 Rated Voltage

The rated voltage shall be determined by the following expression.

$$V = \sqrt{P \times R}$$
 Where V: Rated voltage (V)

R: Nominal resistance value  $(\Omega)$ 

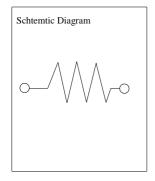
P: Rated dissipation (W)

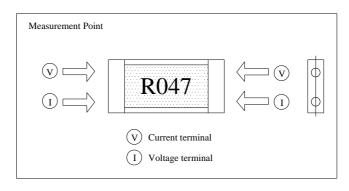
## 4-3 Operation and Storage Temperature Range

$$-55^{\circ}$$
C to  $+125^{\circ}$ C

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# 5. Schematic Diagram. Measurement Point





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# 6. Characteristics

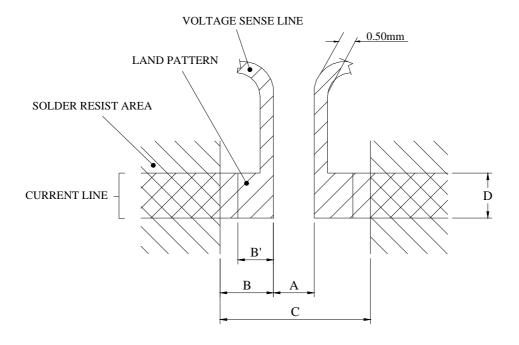
Test Item	Condition of Test	Requirements
Short Time Overload	2.5 * rated voltage for 5 seconds Refer to JIS C 5201-1 4.13	$\Delta R:\pm (0.5\%+0.0005\Omega)$ Without significant damage by flashover ( spark, arching ), burning or breakdown etc.
Insulation Resistance	The resistor shall be cramped in the metal block and tested , as shown below. Test voltage : $100 \pm 15 V_{DC}$ for 1 minute Refer to JIS C 5201-1 4.6 Mounting condition G.	Between Electrode and Protection Film $100 M\Omega$ or over Between Electrode and Substrate $1{,}000 M\Omega$ or over
Voltage Proof	The voltage : 100V <sub>AC</sub> (rms.) for 1 minute Refer to JIS C 5201-1 4.7	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without damage by flashover, fire or breakdown, as shown below.
Thermal Shock	-55 ~125°C 5 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance
Low Temperature Storage	Kept at -55°C, 1,000 hours Refer to JIS C 5201-1 4.23.4	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance
High Temperature Exposure	Kept at 125°C for 1,000 hours Refer to JIS C 5201-1 4.23.2	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance
Solderability	Temperature of Solder : $245 \pm 5^{\circ}$ C Immersion Duration : $3 \pm 0.5$ second Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed
Resistance to Soldering Heat	Dipped into solder at $270 \pm 5^{\circ}$ C for $10 \pm 1$ seconds Refer to JIS C 5201-1 4.18	$\Delta R:\pm (0.5\%+0.0005\Omega)$ Without distinct deformation in appearance

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Test Item	Condition of Test	Requirements
Load Life	Rated voltage for 1.5 hours followed by a pause 0.5 hour at $70 \pm 2^{\circ}$ C.  Cycle repeated 1000 hours  Refer to JIS C 5201-1 4.25	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance
Damp Heat with Load	$60 \pm 2^{\circ}$ C with relative humidity 90% to 95%. D.C. rated voltage for 1.5 hours ON and 30 minutes OFF. Cycle repeated 1,000 hours Refer to JIS C 5201-1 4.24	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance
Mechanical Shock	100 G's for 6milliseconds. 5 pulses Refer to JIS C 5201-1 4.21	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break
Bending Test	Glass-Epoxy board thickness: 1.6mm Bending width: 2mm Between the fulcrums: 90mm Refer to JIS C 5201-1 4.33	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break

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# 7. Recommend Land Pattern



A	В	В'	С	D
3.1	2.75	1.4	7.0	3.05

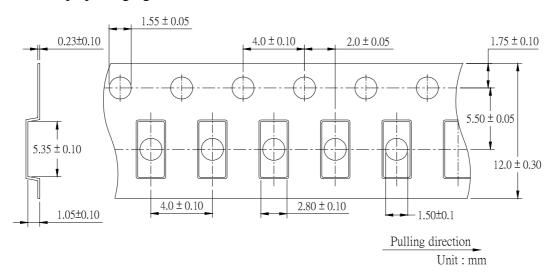
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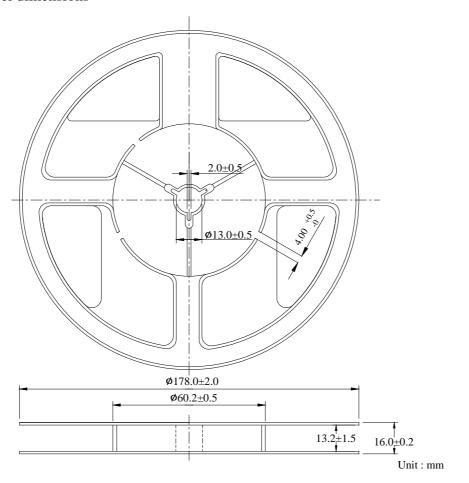
# 8. Packaging

# 8-1 Dimensions

# 8-1-1 Tape packaging dimensions



## 8-1-2 Reel dimensions

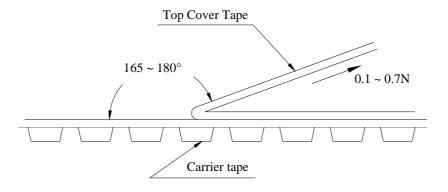


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# 8-2 Peel Strength of Top Cover Tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall between 0.1 to 0.7N



# 8-3 Number of Taping

2,000 pieces / reel

# 8-4 Label marking

The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin

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